SPECIFICATION SHEET



KHZ DIP CERAMIC FILTER GDT TYPE CASE 11070 FB SERIES

SPECIFICATION SHEET NO.	R1010- FB450K0000L112						
ORIGINAL MFG/PART NO	TGS Crystals/CF 450KCW BLH/LTW450KCx						
DATE	Oct. 10, 2024						
REVISION	A4 Updated With Most Recent Data						
DESCRIPTION AND	KHz DIP Ceramic Filter, GDT Type, 5 Pins, FB Series						
	Case 11070, Dimension L11.0*W7.0*H8.0mm						
MAIN PARAMETRICS	450KHz, Insertion Loss. 6.0dB Max.; 6dB Bandwidth: ±12.5KHz Min.						
	Group Delay Time (GDT) Ripple Deviation: 30µSec. Max. within f0 ±10.0KHz						
	Input/Output Impedance: 1500 ohm,						
	Operating Temp. Range -20°C ~+85°C, Package in Bulk						
	REACH/RoHS/RoHS III Compliant, RoHS Annex III lead Exemption						
	(Exempt per RoHS EU 2015/863)						
CUSTOMER							
CUSTOMER PART NUMBER							
CROSS REF. PART NUMBER							
МЕМО							

VENDOR APPROVE Issued/Checked/Approved Date: Oct. 10, 2024

Date:

10/10/2024

NextGen Components, Inc.

CUSTOMER APPROVE



PART CODE: **FB450K0000L112** KHZ DIP CERAMIC FILTER GDT TYPE CASE 11070 FB SERIES

MAIN FEATURE

- KHz DIP Ceramic Filter, GDT Type, 5 Pins, Case 1170
- Black case, Dimension L11.0*W7.0*H8.0mm
- Low Cost And Short Shipment
- Group Delay Time (GDT) Ripple Deviation: 30µSec. Max. within f0 ±10.0KHz
- Reflow Profile Condition 260 °C Max.
- Cross Main Competitors Parts CFWL series
- REACH/RoHS/RoHS III compliant, RoHS Annex III lead Exemption

(Exempt per RoHS EU 2015/863)

APPLICATION

Communication Electronics

HOW TO ORDER

• Please follow up part code guide and indicate part code when you order or RFQ.

PART CODE GUIDE

CODE	NAME	KEY SPECIFICATION OPTION
FB	Product Series	KHz DIP Ceramic Filter, 5 Pins, Case 11070 Dimension L11.0*W7.0*H8.0mm
450K	Frequency Range	450: 450KHz; 455K: 455KHz
0000	Internal Control	Letter or Digits (A~Z, a~z or 1~9)
L	DIP Type Package	Package in bulk
112	Special Parametric	Letter or Digits (A~Z, a~z or 1~9)
- XX	Suffix	Blank: N/A XX: Internal Control Code, Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters

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Image shown is a representation only. Exact specifications should be obtained from the

product dimension.







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PART CODE: **FB450K0000L112**

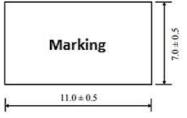
KHZ DIP CERAMIC FILTER GDT TYPE CASE 11070 FB SERIES

DIMENSION (Unit: mm)

Case 11070, 5 Pins

L11.0*W7.0*H8.0mm

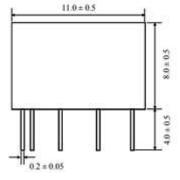
Top View

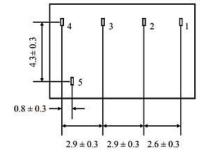


Marking

Line 1: CF or LTW Line 2: Frequency Range + Internal Code

Side View





Connection

1: Pin 1: Input 2: Pin 2: Ground 3: Pin 3, Ground 4: Pin 4: Ground

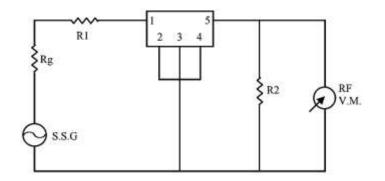
5: Pin 5: Output

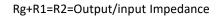
Bottom View



MEASUREMENT

- Measurement shall be carried out at the standard temperature of 25±2°C. If no specific requirements, Test can be carried out under 5-35°C.
- Measuring Circuit





GENERAL ELECTRICAL PARAMETERS

PARAMETER	UNITS	VALUE			CONDITION
		MIN.	TYPICAL	MAX.	
Operation Temperance	°C	-20		+85	
Storage Temperance	°C	-40		+85	
Temperature Stability	%			±0.5	@ -20°C ~+85°C
Stop Band Attenuation	dB	40			@f0±100KHz
Ripple	dB			1.0	@f0 ±3KHz~10KHz
Spurious Response	dB	20			@0.1~1.0MHz
Insulation Resistance	MΩ	100			@DC 25V 1 minute

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PART CODE: **FB450K0000L112**

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ELECTRONICAL RIPPLE PARAMETERS – FOR DIFFERENT PART CODE

Part Code	Center	Min	Bandwidth Max. Insertion		Max. GDT	Input/	
	Freq. (KHz)	@3 dB	@6 dB	@50 dB	Loss @Min. loss point	Ripple Deviation	Output Impedance
			KHz		dB	μsec	Ω
FB450K0000L111	450±1.5	±12.0	±15.0	±30.0	5.0	30 (within f0±10KHz)	1500
FB450K0000L112	450±1.5	±10.0	±12.5	±27.5	6.0	30 (within f0±10KHz)	1500
FB450K0000L113	450±1.0	±8.0	±10.0	±25.0	7.0	30 (within f0±7KHz)	1500
FB450K0000L114	450±1.0	±5.0	±7.50	±20.0	8.0	30 (within f0±5KHz)	1500
FB450K0000L115	450±1.0	±4.5	±6.0	±17.5	8.0	40 (within f0±4.5KHz)	2000
FB450K0000L116	450±1.0	±3.0	±4.5	±15.0	9.0	40 (within f0±3KHz)	2000
FB450K0000L112	455±1.5	±12.0	±15.0	±30.0	5.0	30 (within f0±10KHz)	1500
FB455K0000L112	455±1.5	±10.0	±12.5	±27.5	6.0	30 (within f0±10KHz)	1500
FB455K0000L113	455±1.0	±8.0	±10.0	±25.0	7.0	30 (within f0±7KHz)	1500
FB455K000LG114	455±1.0	±5.0	±7.50	±20.0	8.0	30 (within f0±5KHz)	1500
FB455K0000L115	455±1.0	±4.5	±6.0	±17.5	8.0	40 (within f0±4.5KHz)	2000
FB455K0000L116	455±1.0	±3.0	±4.5	±15.0	9.0	40 (within f0±3KHz)	2000

Note

1. Center Frequency f0 is @Center of 6dB Bandwidth.

2. Specification is subject to changed without notice, please contact us for any update

3. The Parameters in the above table are all general specifications. If you need other Parameters, please contact

us.

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PHYSICAL CHARACTERISTICS

TEST ITEMS	MEASUREMENT CONDITION	REQUIREMENT
Random Drop	Filter shall be measured after 3 times random drops from the height of 30cm on concrete floor	No visible damage and it meet Table at Page 4~5
Vibration	Filter shall be measured after being applied vibration of amplitude of 1.5mm with 10-55Hz band of vibration frequency to each of 3 perpendicular directions for 2 hours	No damage and it meet Table at Page 4~5
Solderability	Lead terminals are immersed in aide solder for 5 sec and then immersed in soldering bath of 230±5°C, for 3±0.5 sec.	At least 95% lead terminals shall be covered with solder.
Substrate Bending Test	Apply pressure in the direction of arrow at a rate of about 0.5mm per second until it reaches a bend of 3mm and hold for 30s.	No damage, no cut-off and it meet Table at Page 4~5
Adhesion	A static load of 20N to the direction of the arrow shall be applied on the core of the component and hold for 10 seconds. Filter shall be soldered correctly and tightly to PCB.	No damage, no cut-off and it meet Table at Page 4~5
Reflow Soldering	Put on the solder paste on the printed wiring board the samples shall be mounted and soldered under the condition, then it shall be subjected to the room atmosphere for 24 hours prior to the measurement.	No damage, no cut-off and it meet Table at Page 4~5

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KHZ DIP CERAMIC FILTER GDT TYPE CASE 11070 FB SERIES

ENVIRONMENTAL CHARACTERISTICS

TEST ITEMS	MEASUREMENT CONDITION	REQUIREMENT
Humidity	After being placed in a chamber with 90-95% R.H. at $40\pm2^{\circ}$ C for 100 hours and then being placed in room	It shall meet Table at Page 4~5
	temperature for 1 hour, filter shall be measured.	
Resistance to Solder Heat	After being placed in a chamber with 80±2°C,for 100 hours and then being placed in room temperature for 1	It shall meet Table at Page
	hour, filter shall be measured.	4 5
High	After being placed in a chamber with 80±2°C,for 100	It shall meet Table at Page
Temperature	hours and then being placed in room temperature for 1	4~5
	hour , filter shall be measured.	
Low	After being placed in a chamber with -20±2°C,for 100	It shall meet Table at Page
Temperature	hours and then being placed in room temperature for 1	4~5
	hour, filter shall be measured.	
Heat Shock	After being kept at room temperature, filter shall be	It shall meet Table at Page
	placed at temperature of –55 $^\circ \! C$, for 30 minutes, then be	4~5
	placed at temperature. 85°C, for 30 minutes. After that	
	returned to –55°C again. Repeated above cycle for 5	
	times. After being kept in room temp. for 1 hour, filter	
	shall be measured	



IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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